

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
WON SANG LEE	08/21/2020
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	RFHIC CORPORATION
<b>Street Address:</b>	RFHIC BUILDING, 41-14, BURIM-RO, 170 BEON-GIL
<b>Internal Address:</b>	GWANYANG-DONG, DONGAN-GU, ANYANG-SI, GYEONGGI-DO
<b>City:</b>	ANYANG-SI
<b>State/Country:</b>	KOREA, REPUBLIC OF
<b>Postal Code:</b>	14055
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	16914477
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<b>NAME OF SUBMITTER:</b>	CHUNG SIK PARK
<b>SIGNATURE:</b>	/Chung.Park/
<b>DATE SIGNED:</b>	08/22/2020
<b>Total Attachments: 4</b>	
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# ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, the individual(s) named below (hereinafter "INVENTOR" whether singular or plural) has sold, assigned, transferred, and set over, and hereby sells, assigns, transfers and sets over, to RFHIC Corporation, a corporation of the Republic of Korea, having a place of business at RFHIC building, 41-14, Burim-ro, 170 beon-gil Gwanyang-dong, Dongan-gu, Anyang-si, Gyeonggi-do, 14055, Republic of Korea ("ASSIGNEE"), for itself and its successors, transferees, and assignees, the following:

1. The full and exclusive worldwide right, title, and interest in and to all inventions and improvements ("SUBJECT MATTER") that are disclosed in the U.S. patent application, entitled "GaN/DIAMOND WAFERS" ("APPLICATION"),

which is a

- (1) ☐ provisional application
  - (a) ☐ bearing Application No., and filed on;
  - (b) ☐ to be filed herewith; or
- (2) ☒ non-provisional application
  - (a) ☒ bearing Application No. 16/914,477, and filed on June 29, 2020;
  - (b) ☐ to be filed herewith;
  - (c) ☐ having an oath or declaration executed on even date herewith prior to filing of application;
  - (d) ☐ having an oath or declaration executed on a different date than this Assignment; and

2. The entire worldwide right, title, and interest in and to the APPLICATION - including the right to claim priority to the APPLICATION - and all applications claiming priority to the APPLICATION or having related SUBJECT MATTER to the APPLICATION, including all such utility, divisional, continuation, substitute, renewal, reissue, international, or other related applications and all rights of priority in the APPLICATION, together with all rights to recover damages for infringement.

INVENTOR hereby authorizes and requests the Commissioner of the U.S. Patent and Trademark Office, and Patent Office Officials in all foreign countries, to issue to the ASSIGNEE any and all patents which may be granted from the APPLICATION.

INVENTOR will, without further consideration, communicate to the ASSIGNEE any facts known to the INVENTOR regarding the SUBJECT MATTER, testify in any legal proceeding, sign all lawful papers, execute all oaths, assignments, powers of attorney, applications and any other paper desired by ASSIGNEE to obtain, perfect, or secure to ASSIGNEE any and all of the rights, titles and interests herein conveyed, and to maintain, enforce, and defend these rights, titles and interests in the United States and all foreign countries. INVENTOR further agrees to provide any successor, assign, or legal representative of ASSIGNEE with the benefits and assistance provided to ASSIGNEE herein.

INVENTOR represents that the INVENTOR, at the time of the execution of this Assignment, is the sole and lawful owner of the entire rights, titles and interests in and to the SUBJECT MATTER as set forth in the APPLICATION, and that the SUBJECT MATTER is unencumbered, and that the INVENTOR has good and full right and lawful authority to sell and convey the SUBJECT MATTER in the manner herein set forth.

INVENTOR covenants with ASSIGNEE that the INVENTOR has not made and will not hereafter make any assignment, grant, mortgage, license or other agreement affecting the rights, titles, and interests herein conveyed.

INVENTOR agrees to, and hereby acknowledges, that the ASSIGNEE may apply for and receive patents related to the APPLICATION or SUBJECT MATTER.

INVENTOR grants the attorney of record for the APPLICATION the power to insert on this Assignment any further identification, including the application number and filing date, which may be necessary or desirable to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

This Assignment may be executed in one or more counterparts, each of which shall be deemed an original and all of which may be taken together as one and the same Assignment. Inventor/assignor signature blocks are located on the following pages.

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INVENTOR Name: Won Sang Lee

INVENTOR Address: 1 Heather Ct,  
Chapel Hill, NC 27517, U.S.A.

INVENTOR Signature: \_\_\_\_\_

DATE of Signature: \_\_\_\_\_

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INVENTOR Name: Won Sang Lee

INVENTOR Address: 1 Heather Ct.

Chapel Hill, NC 27517, U.S.A.

INVENTOR Signature: 

DATE of Signature: Aug. 21, 2000

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